PRELIMINARY

ICS844008-16

FEMTOCLOCKS™ CRYSTAL-TO-LVDS FREQUENCY SYNTHESIZER

GENERAL DESCRIPTION

The ICS844008-16 is an 8 output LVDS Synthesizer optimized to generate PCI Express reference clock frequencies and is a member of the HiPerClocks™ family of high performance clock solutions from IDT. Using a 25MHz parallel resonant crystal, the following frequencies can be generated based on F_SEL pin: 100MHz or 125MHz. The ICS844008-16 uses IDT's 3rd generation low phase noise VCO technology and can achieve <1ps typical rms phase jitter, easily meeting PCI Express jitter requirements. The ICS844008-16 is packaged in a 32-pin LQFP package.

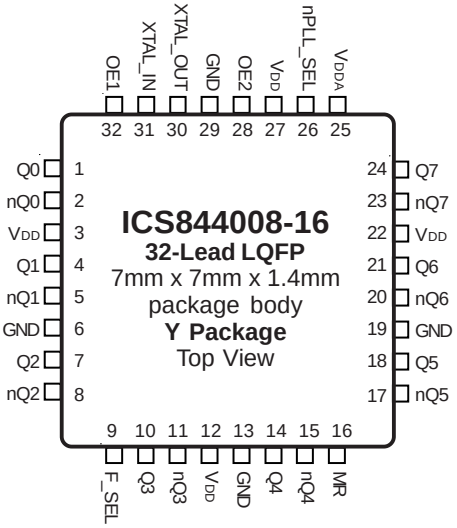
FEATURES

- Eight LVDS outputs
- Crystal oscillator interface
- Supports the following output frequencies: 100MHz or 125MHz
- VCO: 500MHz
- RMS phase jitter @ 125MHz, using a 25MHz crystal (1.875MHz - 20MHz): 0.44ps (typical)
- Full 3.3V supply modes
- 0°C to 70°C ambient operating temperature
- Available in both standard (RoHS5) and lead-free (RoHS 6) packages

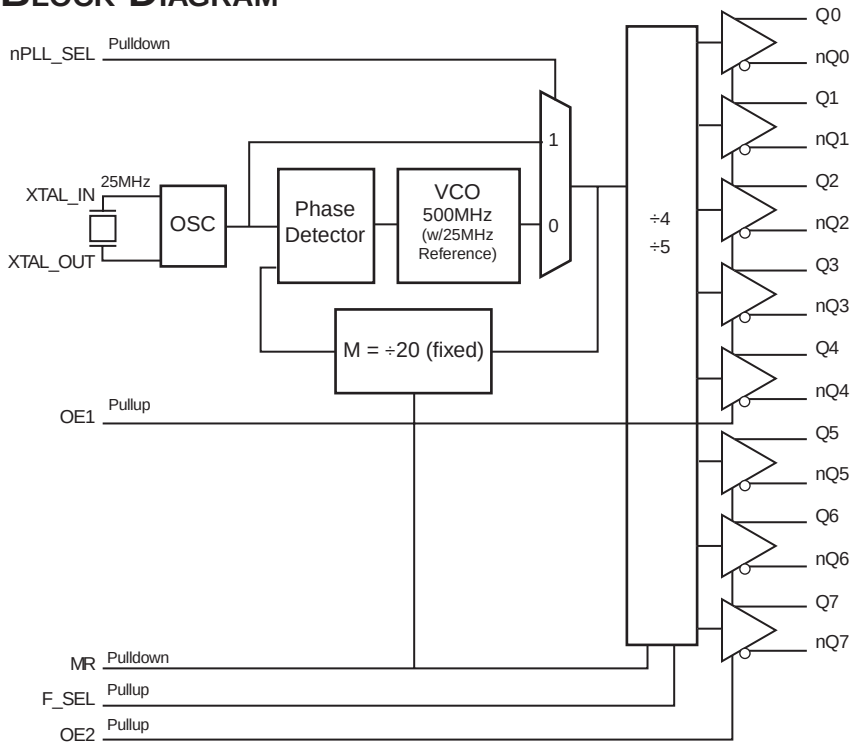
FREQUENCY SELECT FUNCTION TABLE

Input					Output
Input Frequency (MHz)	F_SEL	M Divider Value	N Divider Value	M/N Divider Value	Output Frequency (MHz)
25MHz	0	20	4	5	125
25MHz	1	20	5	4	100

PIN ASSIGNMENT



BLOCK DIAGRAM



The Preliminary Information presented herein represents a product in pre-production. The noted characteristics are based on initial product characterization and/or qualification. Integrated Device Technology, Incorporated (IDT) reserves the right to change any circuitry or specifications without notice.

TABLE 1. PIN DESCRIPTIONS

Number	Name	Type		Description
1, 2	Q0, nQ0	Output		Differential output pair. LVDS interface levels.
3, 12, 22, 27	V_{DD}	Power		Core supply pin.
4, 5	Q1, nQ1	Ouput		Differential output pair. LVDS interface levels.
6, 13, 19, 29	GND	Power		Power supply ground.
7, 8	Q2, nQ2	Output		Differential output pair. LVDS interface levels.
9	F_SEL	Input	Pullup	Frequency select pin LVCMOS/LVTTL interface levels.
10, 11	Q3, nQ3	Output		Differential output pair. LVDS interface levels.
14, 15	Q4, nQ4	Output		Differential output pair. LVDS interface levels.
16	MR	Input	Pulld-own	Active HIGH Master Reset. When logic HIGH, the internal dividers are reset causing the true outputs Qx to go low and the inverted outputs nQx to go high. When logic LOW, the internal dividers and the outputs are enabled. LVCMOS/LVTTL interface levels.
17, 18	nQ5, Q5	Output		Differential output pair. LVDS interface levels.
20, 21	nQ6, Q6	Output		Differential output pair. LVDS interface levels.
23, 24	nQ7, Q7	Output		Differential output pair. LVDS interface levels.
25	V_{DDA}	Power		Analog supply pin.
26	nPLL_SEL	Input	Pulld-own	Selects between the PLL and REF_CLK as input to the dividers. When LOW, selects PLL (PLL Enable). When HIGH, deselects the reference clock (PLL Bypass). LVCMOS/LVTTL interface levels.
28	OE2	Input	Pullup	Output enable for Q5/nQ5:Q7/nQ7 outputs. LVCMOS/LVTTL interface levels.
30, 31	XTAL_OUT, XTAL_IN	Input		Parallel resonant crystal interface. XTAL_OUT is the output, XTAL_IN is the input.
32	OE1	Input	Pullup	Output enable for Q0/nQ0:Q4/nQ4 outputs. LVCMOS/LVTTL interface levels.

NOTE: *Pullup* refers to internal input resistors. See Table 2, Pin Characteristics, for typical values.

TABLE 2. PIN CHARACTERISTICS

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
C_{IN}	Input Capacitance			4		pF
$R_{PULLDOWN}$	Input Pulldown Resistor			51		kΩ
R_{PULLUP}	Input PullUP Resistor			51		kΩ

TABLE 3A. OE1 FUNCTION TABLE

Input	Outputs
OE1	**Q0:Q4, nQ0:nQ4**
0	Places outputs in Hi-Z state
1	Normal operation

TABLE 3B. OE2 FUNCTION TABLE

Input	Outputs
OE2	**Q5:Q7, nQ5:nQ7**
0	Places outputs in Hi-Z state
1	Normal operation

ABSOLUTE MAXIMUM RATINGS

Supply Voltage, V_{DD}	4.6V
Inputs, V_I	-0.5V to V_{DD} + 0.5V
Outputs, I_O	
Continuous Current	10mA
Surge Current	15mA
Package Thermal Impedance, θ_{JA}	47.9°C/W (0 lfpm)
Storage Temperature, T_{STG}	-65°C to 150°C

NOTE: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These ratings are stress specifications only. Functional operation of product at these conditions or any conditions beyond those listed in the *DC Characteristics* or *AC Characteristics* is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

TABLE 4A. POWER SUPPLY DC CHARACTERISTICS, V_{DD} = 3.3V±5%, T_A = 0°C TO70°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V_{DD}	Core Supply Voltage		3.135	3.3	3.465	V
V_{DDA}	Analog Supply Voltage		3.135	3.3	3.465	V
I_{DD}	Power Supply Current			285		mA
I_{DDA}	Analog Supply Current			12		mA

TABLE 4B. LVCMOS / LVTTL DC CHARACTERISTICS, V_{DD} = 3.3V±5%, T_A = 0°C TO70°C

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
V_{IH}	Input High Voltage		V_{DD} = 3.3V	2		V_{DD} + 0.3	V
V_{IL}	Input Low Voltage		V_{DD} = 3.3V	-0.3		0.8	V
I_{IH}	Input High Current	MR, nPLL_SEL	V_{DD} = V_{IN} = 3.465			150	µA
		OE1, OE2, F_SEL	V_{DD} = V_{IN} = 3.465			5	µA
I_{IL}	Input Low Current	MR, nPLL_SEL	V_{DD} = 3.465V, V_{IN} = 0V	-5			µA
		OE1, OE2, F_SEL	V_{DD} = 3.465V, V_{IN} = 0V	-150			µA

TABLE 4C. LVDS DC CHARACTERISTICS, V_{DD} = 3.3V±5%, T_A = 0°C TO70°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V_{OD}	Differential Output Voltage			440		mV
ΔV_{OD}	V_{OD} Magnitude Change			40		mV
V_{OS}	Offset Voltage			1.4		V
ΔV_{OS}	V_{OS} Magnitude Change			50		mV

TABLE 5. CRYSTAL CHARACTERISTICS

Parameter	Test Conditions	Minimum	Typical	Maximum	Units
Mode of Oscillation		Fundamental			
Frequency		22.4	25	27.2	MHz
Parts per Million (ppm); NOTE 1				100	ppm
Equivalent Series Resistance (ESR)				50	Ω
Shunt Capacitance				7	pF
Drive Level				100	µW

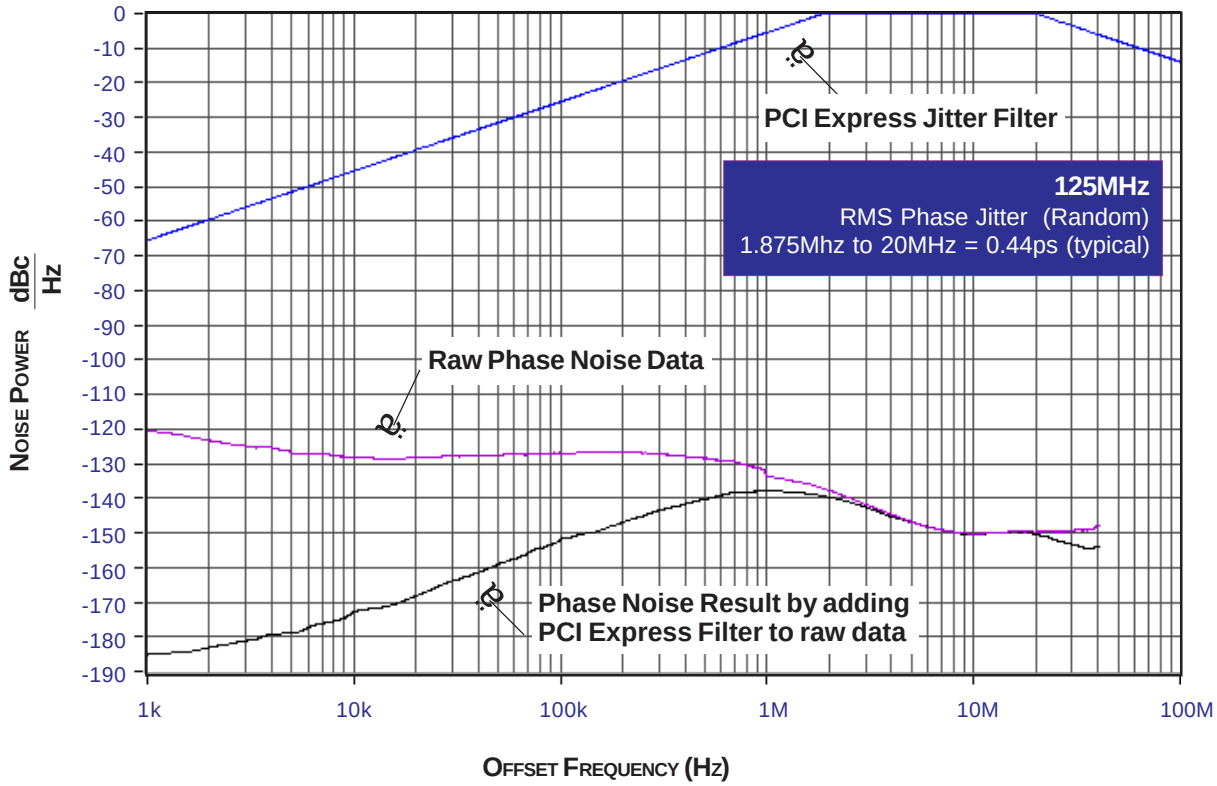
NOTE: Characterized using an18pF parallel resonant crystal.
NOTE 1: When used with recommended 50ppm crystal and external trim caps adjusted for user PC board.

TABLE 6. AC CHARACTERISTICS, V_{DD} = 3.3V±5%, T_A = 0°C TO70°C

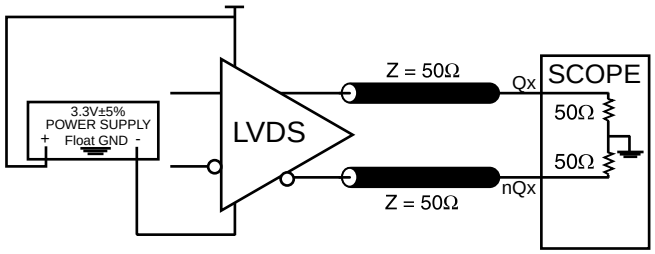
Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
f_{OUT}	Output Frequency	FSEL = 0		125		MHz
		FSEL = 1		100		MHz
*t*sk(o)	Output Skew; NOTE 1, 2			TBD		ps
*t*jit(cc)	Cycle-to-Cycle Jitter			40		ps
*t*jit(Ø)	RMS Phase Jitter (Random); NOTE 3	125MHz, (1.875MHz - 20MHz)		0.44		ps
		100MHz, (1.875MHz - 20MHz)		0.44		ps
t_R / t_F	Output Rise/Fall Time	20% to 80%		450		ps
odc	Output Duty Cycle			50		%

NOTE 1: Defined as skew between outputs at the same supply voltages and with equal load conditions. Measured at V_{DD}/2.
NOTE 2: This parameter is defined in accordance with JEDEC Standard 65.
NOTE 3: Please refer to the Phase Noise Plot.

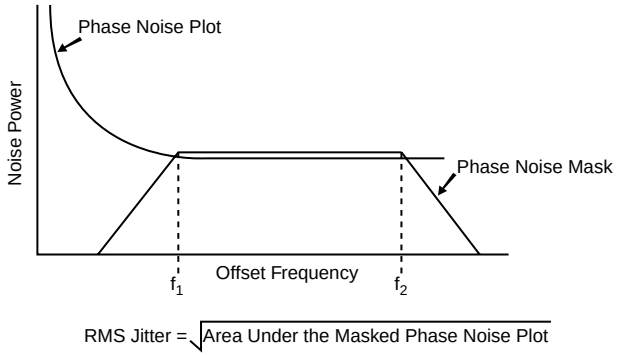
TYPICAL PHASE NOISE AT 125MHZ AT 3.3V



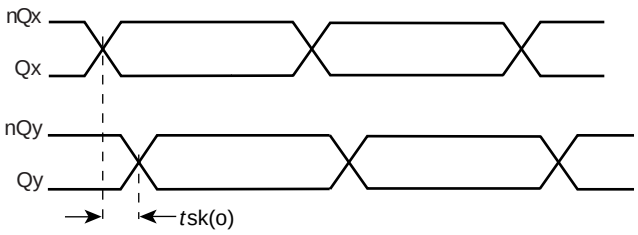
PARAMETER MEASUREMENT INFORMATION



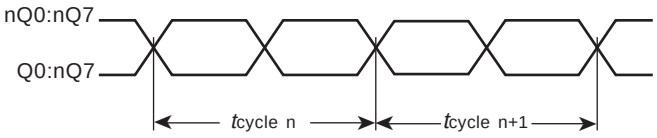
3.3V CORE/3.3V OUTPUT LOAD AC TEST CIRCUIT



RMS PHASE JITTER



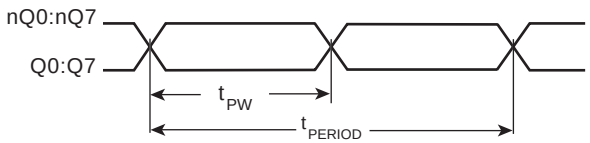
OUTPUT SKEW



$t_{jit(cc)} = t_{cycle\ n} - t_{cycle\ n+1}$

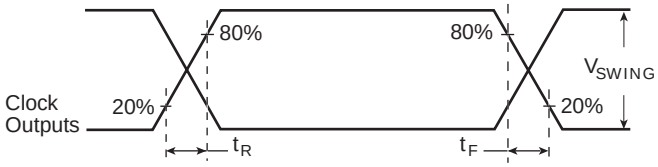
1000 Cycles

CYCLE-TO-CYCLE JITTER

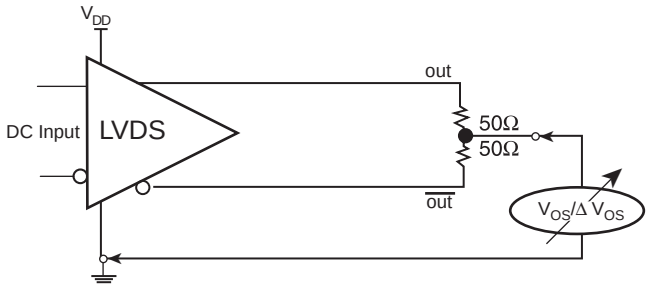


$$odc = \frac{t_{PW}}{t_{PERIOD}} \times 100\%$$

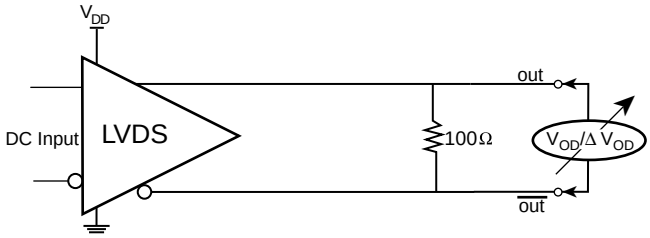
OUTPUT DUTY CYCLE/PULSE WIDTH/PERIOD



OUTPUT RISE/FALL TIME



OFFSET VOLTAGE SETUP



DIFFERENTIAL OUTPUT VOLTAGE SETUP

APPLICATION INFORMATION

POWER SUPPLY FILTERING TECHNIQUES

As in any high speed analog circuitry, the power supply pins are vulnerable to random noise. The ICS844008-16 provides separate power supplies to isolate any high switching noise from the outputs to the internal PLL. V_{DD} and V_{DDA} should be individually connected to the power supply plane through vias, and bypass capacitors should be used for each pin. To achieve optimum jitter performance, power supply isolation is required. *Figure 1* illustrates how a 10Ω resistor along with a 10µF and a .01µF bypass capacitor should be connected to each V_{DDA}.

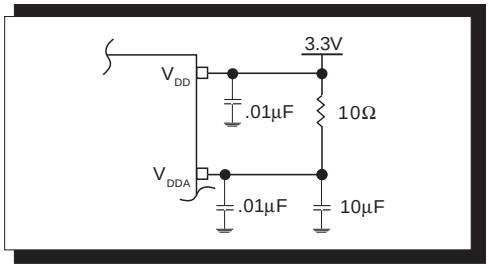


FIGURE 1. POWER SUPPLY FILTERING

CRYSTAL INPUT INTERFACE

The ICS844008-16 has been characterized with 18pF parallel resonant crystals. The capacitor values shown in *Figure 2* below were determined using a 25MHz parallel resonant crystal and were chosen to minimize the ppm error.

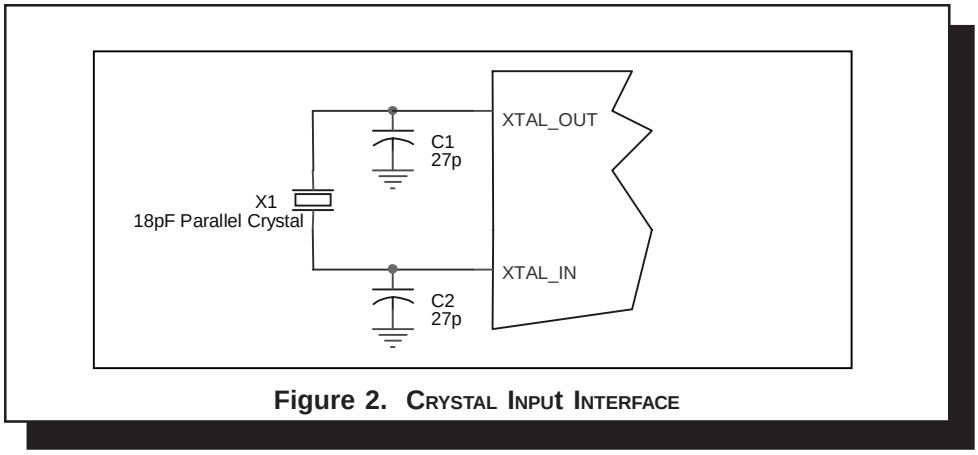


Figure 2. CRYSTAL INPUT INTERFACE

RECOMMENDATIONS FOR UNUSED INPUT AND OUTPUT PINS

INPUTS:

LVCMOS CONTROL PINS:

All control pins have internal pull-ups or pull-downs; additional resistance is not required but can be added for additional protection. A 1kΩ resistor can be used.

OUTPUTS:

LVDS

All unused LVDS output pairs can be either left floating or terminated with 100Ω across. If they are left floating, we recommend that there is no trace attached.

3.3V LVDS DRIVER TERMINATION

A general LVDS interface is shown in *Figure 3.* In a 100Ω differential transmission line environment, LVDS drivers require a matched load termination of 100Ω across near the receiver input. For a multiple LVDS outputs buffer, if only partial outputs are used, it is recommended to terminate the unused outputs.

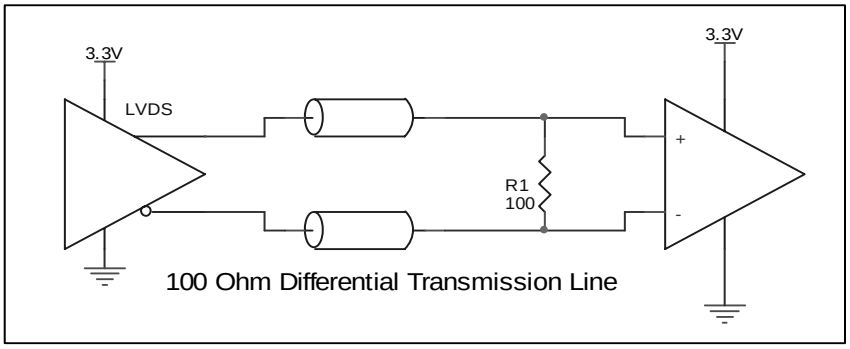


FIGURE 3. TYPICAL LVDS DRIVER TERMINATION

POWER CONSIDERATIONS

This section provides information on power dissipation and junction temperature for the ICS844008-16. Equations and example calculations are also provided.

1. Power Dissipation.
The total power dissipation for the ICS844008-16 is the sum of the core power plus the power dissipated in the load(s). The following is the power dissipation for V_{DD} = 3.3V + 5% = 3.465V, which gives worst case results.

- Power (core)$_{MAX}$ = V_{DD_MAX} * (I_{DD_MAX} + I_{DDA_MAX}) = 3.465V * (285mA + 12mA) = **1029mW**

2. Junction Temperature.
Junction temperature, Tj, is the temperature at the junction of the bond wire and bond pad and directly affects the reliability of the device. The maximum recommended junction temperature for HiPerClockS™ devices is 125°C.

The equation for Tj is as follows: $Tj = \theta_{JA} * Pd\_total + T_A$

Tj = Junction Temperature

θ_{JA} = Junction-to-Ambient Thermal Resistance

Pd_total = Total Device Power Dissipation (example calculation is in section 1 above)

T_A = Ambient Temperature

In order to calculate junction temperature, the appropriate junction-to-ambient thermal resistance θ_{JA} must be used. Assuming a moderate air flow of 200 linear feet per minute and a multi-layer board, the appropriate value is 42.1°C/W per Table 7 below.

Therefore, Tj for an ambient temperature of 70°C with all outputs switching is:
70°C + 1.029W * 42.1°C/W = 113.3°C. This is below the limit of 125°C.

This calculation is only an example. Tj will obviously vary depending on the number of loaded outputs, supply voltage, air flow, and the type of board (single layer or multi-layer).

TABLE 7. THERMAL RESISTANCE θ_{JA} FOR 32-LEAD LQFP, FORCED CONVECTION

θ_{JA} by Velocity (Linear Feet per Minute)			
	0	**200**	**500**
Single-Layer PCB, JEDEC Standard Test Boards	67.8°C/W	55.9°C/W	50.1°C/W
Multi-Layer PCB, JEDEC Standard Test Boards	47.9°C/W	42.1°C/W	39.4°C/W

NOTE: Most modern PCB designs use multi-layered boards. The data in the second row pertains to most designs.

RELIABILITY INFORMATION

TABLE 8. θ_{JA} VS. AIR FLOW TABLE FOR 32 LEAD LQFP

θ_{JA} by Velocity (Linear Feet per Minute)			
	0	**200**	**500**
Single-Layer PCB, JEDEC Standard Test Boards	67.8°C/W	55.9°C/W	50.1°C/W
Multi-Layer PCB, JEDEC Standard Test Boards	47.9°C/W	42.1°C/W	39.4°C/W

NOTE: Most modern PCB designs use multi-layered boards. The data in the second row pertains to most designs.

TRANSISTOR COUNT

The transistor count for ICS844008-16 is: 2597

PACKAGE OUTLINE -Y SUFFIX FOR 32 LEAD LQFP

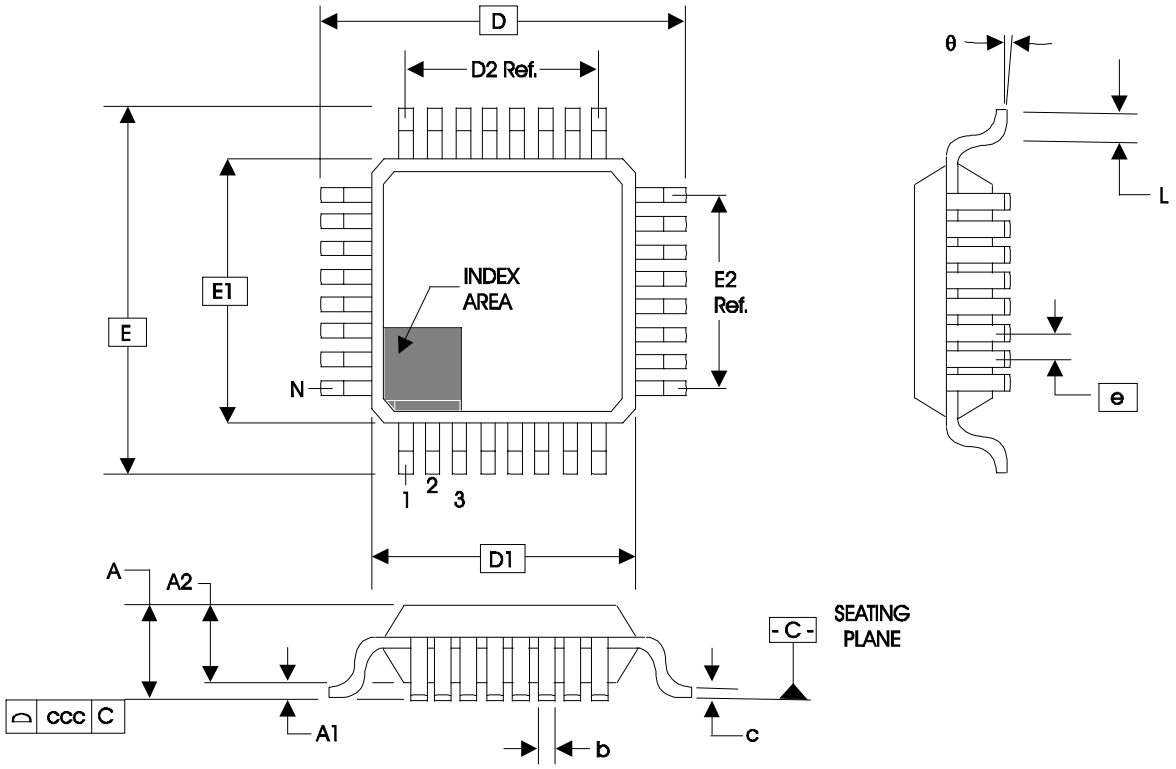


TABLE 9. PACKAGE DIMENSIONS

JEDEC VARIATION ALL DIMENSIONS IN MILLIMETERS			
SYMBOL	BBA		
	MINIMUM	NOMINAL	MAXIMUM
N		32	
A	--	--	1.60
A1	0.05	--	0.15
A2	1.35	1.40	1.45
b	0.30	0.37	0.45
c	0.09	--	0.20
D		9.00 BASIC	
D1		7.00 BASIC	
D2		5.60 Ref.	
E		9.00 BASIC	
E1		7.00 BASIC	
E2		5.60 Ref.	
e		0.80 BASIC	
L	0.45	0.60	0.75
θ	0°	--	7°
ccc	--	--	0.10

Reference Document: JEDEC Publication 95, MS-026

TABLE 10. ORDERING INFORMATION

Part/Order Number	Marking	Package	Shipping Packaging	Temperature
ICS844008AY-16	ICS844008A16	32 Lead LQFP	tube	0°C to 70°C
ICS844008AY-16T	ICS844008A16	32 Lead LQFP	1000 tape & reel	0°C to 70°C
ICS844008AY-16LF	ICS44008A16L	32 Lead "Lead-Free" LQFP	tube	0°C to 70°C
ICS844008AY-16LFT	ICS44008A16L	32 Lead "Lead-Free" LQFP	1000 tape & reel	0°C to 70°C

NOTE: parts that are ordered with an "LF" suffix to the part number are the Pb-Free configuration and are RoHS compliant.